EVERLIGHT

DATASHEET

SMD • Side View LEDs

99-218UM2C/3438S97/TR8-T

Features

- . Side view white LED.
- . White SMT package.
- . Lead frame package with individual 2 pins.
- . Wide viewing angle.
- . Soldering methods: IR reflow soldering.
- . Pb-free.
- . The product itself will remain within RoHS compliant version.

Descriptions

. Due to the package design, 99-218 has wide viewing angle , low power consumption and white LEDs are devices which are materialized by combing Blue LEDs and special phosphors . This feature makes the LED ideal for light guide application.

Applications

- . Mobile phones .
- . Indicators.
- . Illuminations.
- . Switch Lights.

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Coding:

99-218UM2C/ <u>XX</u> <u>XX</u> <u>XX</u> <u>X</u> /TR8-T							
Bin Group of Forward Voltage Bin Group of Chromaticity Coordinates Bin Code of Max. Luminous Intensity Bin Code of Min. Luminous Intensity							
Device Selection Guide							
Chip Emitted	Color	Resin Cold	or				
Materials							
InGaN Pure Wr	nite	Water Clear					
Absolute Maximum Ratings (Ta=25°C)							
Parameter	Symbol	Rating	Unit				
Reverse Voltage	VR	5	V				
Forward Current	lF	30	mA				
Peak Forward Current (Duty 1/10 @10ms)	I _{FP}	60	mA				
Power Dissipation	Pd	110	mW				
Operating Temperature	T _{opr}	-40 ~ +85	°C				
Storage Temperature	T _{stg}	-40 ~ +90	C°				
Soldering Temperature	T _{sol}	Reflow Soldering : 260 °C Hand Soldering : 350 °C					

Notes: *1The products are sensitive to static electricity and must be carefully taken when handling products.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	2000		2300	mcd	
Viewing Angle	20 1/2		120		deg	I _F =20mA
Forward Voltage	VF	2.95		3.25	V	-
Reverse Current	I _R			50	μA	V _R =5V

Bin Range of Luminous Intensity

Bin Code	mcd(Min.)	mcd(Max.)	Unit	Condition	lm(Min.)	lm(Max.)	Unit
38	2000	2050			5.60	5.74	
39	2050	2100			5.74	5.88	
40	2100	2150	mcd	I _F =20mA	5.88	6.02	lm
41	2150	2200			6.02	6.16	
42	2200	2300			6.16	6.44	
	<i>.</i>						

Notes: Tolerance of Luminous Intensity, Luminous Flux: ±5%.

The spec. for intensity is quantified in Im, mcd is for reference only.

Bin Range of Forward Voltage

Group	Bin Code	Min.	Max.	Unit	Condition
	6-1	2.95	3.05		
7	6-2	3.05	3.15	V	I _F =20mA
	7-1	3.15	3.25	_	

Note: Tolerance of Forward Voltage: ±0.05V

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Issue No: DSE-0008019

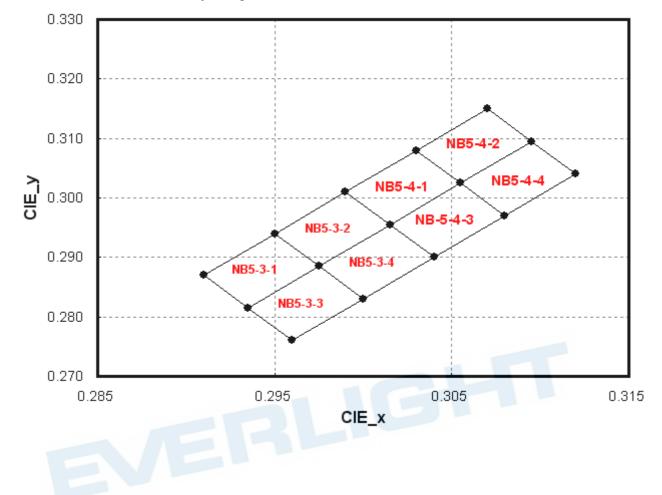
Chromaticity Coordinates of Bin Code

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
NB5-3-1	0.2935	0.2815		0.2975	0.2885
	0.2910	0.2870	– NB5-3-2 –	0.2950	0.2940
	0.2950	0.2940		0.2990	0.3010
	0.2975	0.2885		0.3015	0.2955
	0.2960	0.2760		0.3000	0.2830
NB5-3-3	0.2935	0.2815	– NB5-3-4 –	0.2975	0.2885
ND3-3-3	0.2975	0.2885	ND5-5-4	0.3015	0.2955
	0.3000	0.2830		0.3040	0.2900
	0.3015	0.2955		0.3055	0.3025
NB5-4-1	0.2990	0.3010	– NB5-4-2 –	0.3030	0.3080
NDJ-4-1	0.3030	0.3080	NDJ-4-2	0.3070	0.3150
	0.3055	0.3025		0.3095	0.3095
NB5-4-3	0.3040	0.2900		0.3080	0.2970
	0.3015	0.2955		0.3055	0.3025
	0.3055	0.3025	NB5-4-4	0.3095	0.3095
	0.3080	0.2970	_	0.3120	0.3040

Note: Tolerance of Chromaticity Coordinates: ±0.01

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The C.I.E. 1931 Chromaticity Diagram

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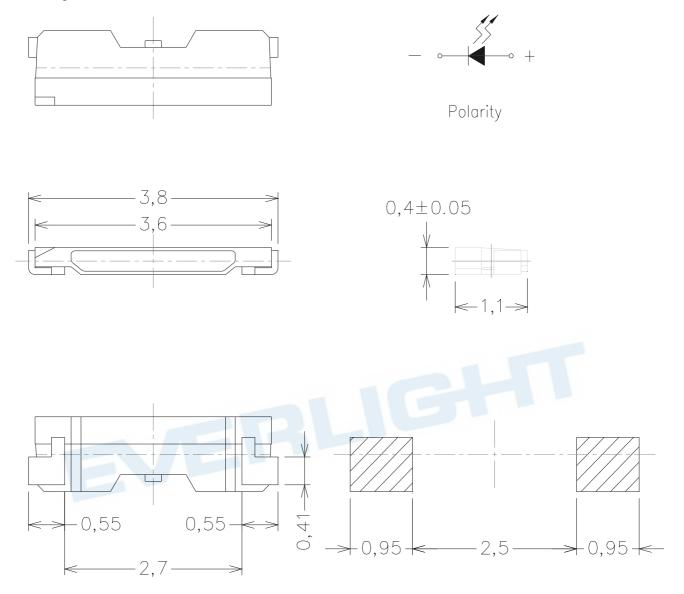
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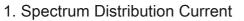
Package Outline Dimensions



Note: The tolerances unless dimensions are ± 0.1mm.

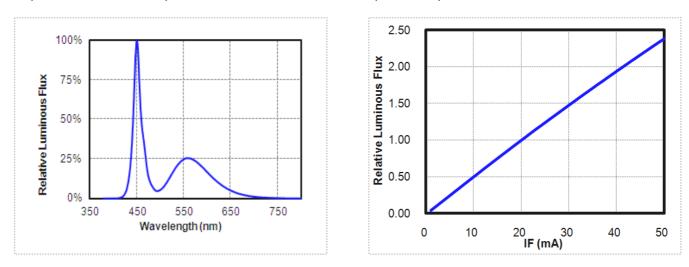
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Typical Electro-Optical-Thermal Characteristics Curves

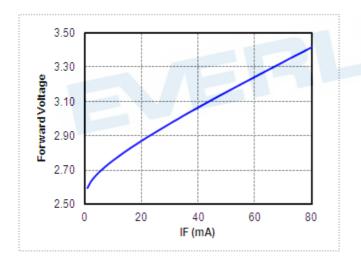


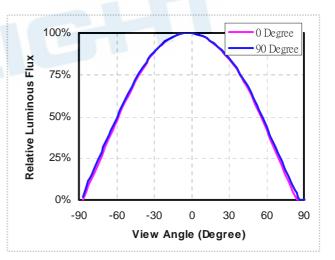
(T_A=25°C, I_F=20mA)

2. Relative Luminous flux vs. Forward (T_A=25°C)



3. Relative Forward Voltage vs. Forward Current 4. Radiation Diagram (T_A=25°C) (T_A=25°C, I_F=20mA)





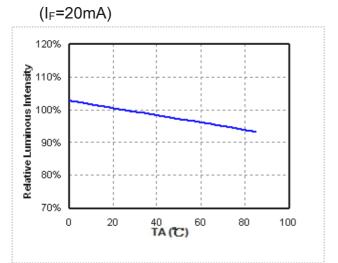
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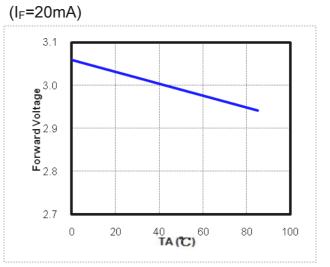
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Typical Electro-Optical-Thermal Characteristics Curves

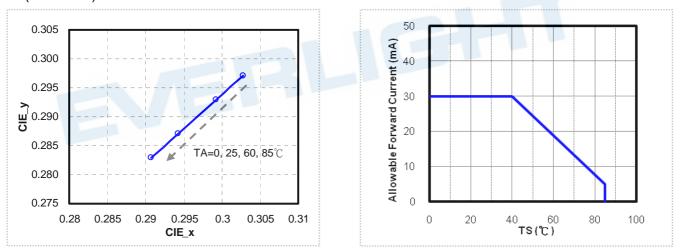
- 5. Relative Luminous Intensity vs. Solder Temperature
- 6. Forward Voltage vs. Solder

Temperature





7. Chromaticity Coordinates vs. Solder Temperature 8. Forward Current De-rating Curve (I_F=20mA)



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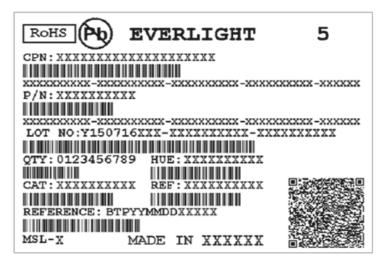
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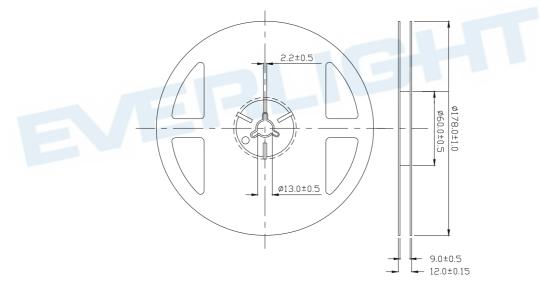
Label Explanation

CAT: Luminous Flux Rank HUE: Chromaticity Coordinates

REF: Forward Voltage Rank



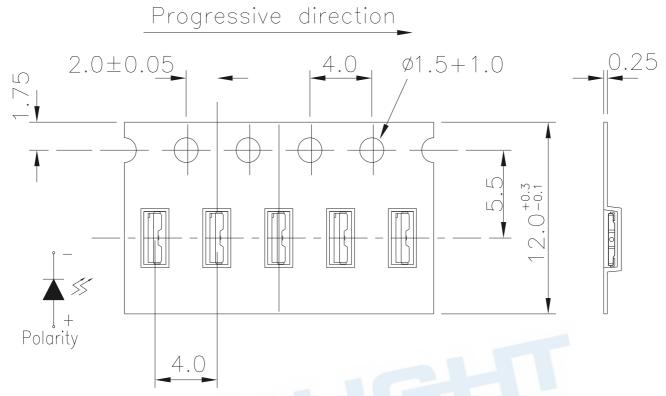
Reel Dimensions



Note: The tolerances unless dimension are ± 0.1mm.

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Issue No: DSE-0008019

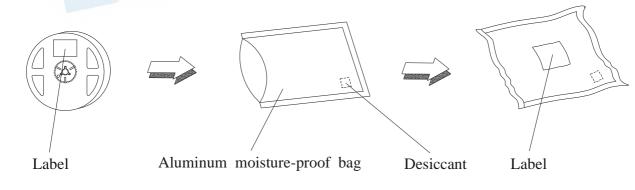
Carrier Tape Dimensions: Loaded Quantity 250 up/500/1000/2000 pcs. Per Reel



Note: The tolerances unless mentioned is ±0.1mm,Unit = mm.

Moisture Resistant Packaging

Issue No: DSE-0008019



Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

		Test Conditio	Test	Criteria			
NO	Item —	Temp./ Humidity	l _⊧ (mA)	 Hours / Times 	Iv @ 20mA	V _F @ 20mA	
1	Reflow Soldering	TSId = 260°C, Max.	10sec.	2 times	<±10%	<±10%	
2	Temperature cycle		00°C 30min.	200 cycles			
3	Thermal Shock	-10℃ ~ 1 20min. (<15sec.)	00°C 20min.	200 cycles			
4	Low Temp. Storage	Ta= -40°C		1000 hrs			
5	High Temp. Storage	Ta= 100°C		1000 hrs			
6	Temp. Humidity Storage	Ta= 60°C/ 90%RH		1000 hrs		700/	
7	Steady State Operating Life of Low Temp.	Ta= -40°C	20	1000 hrs	lv > 7 VF < 7		
8	Steady State Operating Life Condition 1	Ta= 25°C/ Room Humidity	20	1000 hrs			
9	Steady State Operating Life Condition 2	Ta= 60°C	20	1000 hrs			
10	Steady State Operating Life of High Temp.	Ta= 85°C	5	1000 hrs			
11	Steady State Operating Life of High Humidity Heat	Ta= 60°C/ 90%RH	20	1000 hrs			

Notes:

1. Sampling for each test item: 22 (pcs.)

2. Measurements are performed after allowing the LEDs to return to room temperature.

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Issue No: DSE-0008019

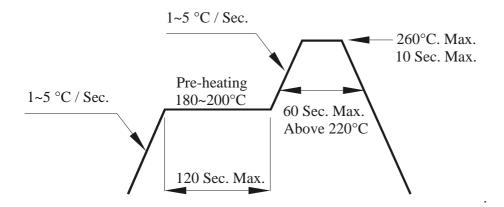
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Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be used within one year and kept at 30°C or less and 70%RH or less.
 - 2.3 After opening the package: We recommend that the LED should be soldered quickly (within 3 days). The soldering condition is 30°C or less and 60%RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours. (One time only)
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

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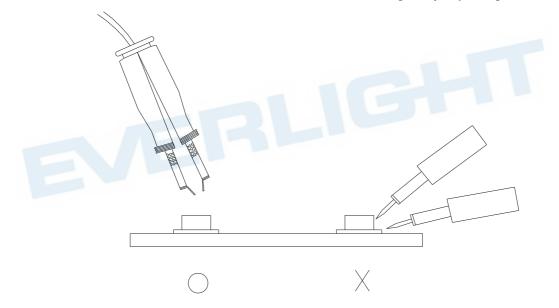
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.

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